



Molded Inductor 5.6µH

# APPLICATIONS



- Battery-powered devices
- Portable devices
- Embedded computing
- High-current SMPS
- High-frequency SMPS
- POL converters
- FPGA

## **FEATURES**

- Size 4.45mmx4.1mmx1.8mm
- Molded Construction
- Low Audible Noise
- Soft Saturation
- Stable Over High Temperatures
- Max Operating Temp +155°C
- RoHS/REACH-Compliant, Halogen-Free

ELECTRICAL CHARACTERISTICS					
Parameter			Value	Unit	
Inductance (1)	L	±20%	5.6	μH	
Resistance	<b>R</b> <sub>DC</sub>	typ	97	mΩ	
Resistance MAX	RDC MAX	max	116	mΩ	
Rated Current (2)	<b>I</b> <sub>R</sub>	typ	2.45	Α	
Saturation Current <sub>25°C</sub> (3)	ISAT 25°C	typ	2.6	Α	
Saturation Current 100°C (4)	ISAT 100°C	typ	2.6	Α	
Resonance Frequency	fr	typ	23	MHz	

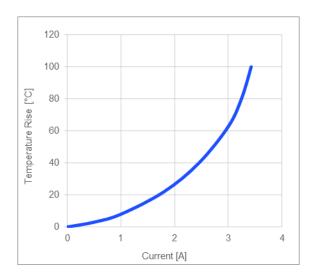
GENERAL SPECIFICATIONS		
(1) Inductance	Measured at 100kHz, 100mA	
(2) Rated Current	Rated current will cause the coil temperature rise $\Delta T$ of 40K $I_R$ measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35 $\mu$ m Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.	
(3) Saturation Current 25°C	Saturation current will cause L to drop from 30% at 25°C ambient temperature	
(4) Saturation Current 100°C	Saturation current will cause L to drop from 30% at 100°C ambient temperature	
<b>Temperature Test Condition</b>	Electrical specifications measured at 25°C, 35% RH if not given differently	
Operating Condition	Operating temperature: -40°C to +155°C (including temp rise)	
	Should not exceed +155°C under worst-case operation conditions	
Storage Condition	Tape and Reel packaging: -10°C to +40°C  Humidity: <50% RH	

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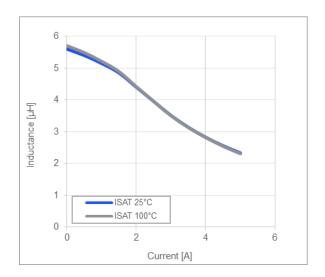


# **TYPICAL PERFORMANCE CURVES**

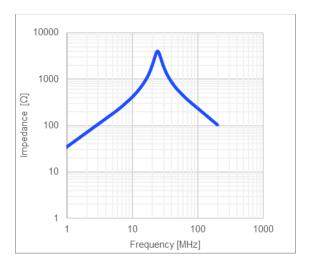
## **Temperature Rise vs. Current**



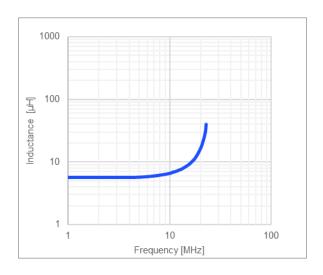
#### **Inductance vs. Current**



Impedance vs. Frequency

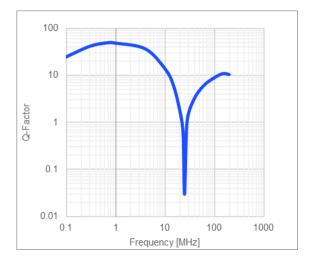


Inductance vs. Frequency

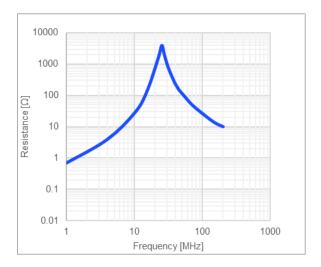




## **Quality Factor vs. Frequency**



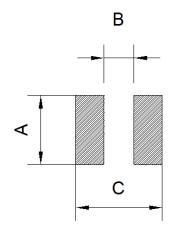
# AC Resistance vs. Frequency



3



LAND PATTERN			
Dimensions			
Α	2.50 ref.		
В	2.20 ref.		
С	5.20 ref.		
	(unit in mm)		



**TOP MARKING** 

Start of Winding

Inductance Code

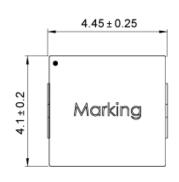
**Marking** 

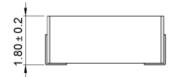
· (dot) 5R6

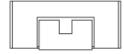
# PRODUCT PACKAGE AND DIMENSIONS

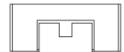
## **Dimensions**

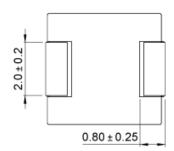
(unit in mm)













ORDERING INFORMAT	TON				
Part Number	L (1)	RDC	I <sub>R</sub> <sup>(2)</sup>	I <sub>SAT 25°C</sub> (3)	I <sub>SAT 100°C</sub> (4)
	typ (µH)	typ (mΩ)	typ (A)	typ (A)	typ (A)
MPL-AY4020-5R6	5.6	97	2.45	2.6	2.6
MPL-AY4020-6R8	6.8	129	2.20	2.4	2.4
MPL-AY4020-8R2	8.2	136	2.10	2.1	2.1
MPL-AY4020-100	10	163	1.90	2	2

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